

## MRH570.16-416F3

### Thyristor/Diode module

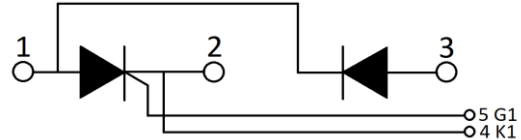
#### Features:

- Pressure contact technology with increased power cycling capability
- Glass passivated chip
- Simple mounting
- UL recognized, file no. E312789



#### Typical applications:

- Power converters
- Lighting control
- DC motor control and drives
- Heat and temperature control



Symbol	Characteristics	Test Conditions	Value			Unit
			Min	Typ	Max	
$V_{RSM/DSM}$	Non-repetitive reverse/forward blocking voltage	$T_j = 25^\circ\text{C}$			1700	V
$V_{RRM/DRM}$	Repetitive reverse/forward blocking voltage	$T_j = 25^\circ\text{C}$			1600	V
$I_T \cdot I_{F(AV)}$	On-state/forward average current	180° half sine wave 50Hz			570	A
$I_T \cdot I_{F(RMS)}$	RMS on-state current	$T_c = 85^\circ\text{C}$			895	A
$I_{RRM}$ $I_{DRM}$	Repetitive peak current	at $V_{DRM}/V_{RRM}$ $T_j = 125^\circ\text{C}$			35	mA
$I_{TSM} \cdot I_{FSM}$	Surge non repetitive current	10ms half sine wave $T_j = 125^\circ\text{C}$			15000	A
$I^2 t$	$I^2 t$ for fusing coordination	10ms half sine wave $V_R = 60\% V_{RRM}$ $T_j = 125^\circ\text{C}$			1125000	$\text{A}^2\text{s}$
$V_{TO}$	Threshold voltage	$T_j = 125^\circ\text{C}$			0.80	V
$r_T$	On-state slope resistance	$T_j = 125^\circ\text{C}$			0.20	$\text{m}\Omega$
$V_{TM} \cdot V_{FM}$	Thyristor: Peak on-state voltage	$T = 25^\circ\text{C}$ ; $I_{T-F} = 750\text{A}$			1.45	V
$dv/dt$	Critical rate of rise of off-state voltage	$V_{DM} = 67\% V_{DRM}$ , $T_j = 125^\circ\text{C}$ , linear voltage rise			1000	$\text{V}/\mu\text{s}$
$di/dt$	Critical rate of rise of off-state current	$T_j = 125^\circ\text{C}$ , Gate source 500mA, $T_r < 0,5\mu\text{s}$ Repetitive			200	$\text{A}/\mu\text{s}$
$I_{GT}$	Gate trigger current	$V_A = 12\text{V}$ , $T_j = 25^\circ\text{C}$	30		200	mA
$V_{GT}$	Gate trigger voltage		1.0		3.0	V
$I_H$	Holding current	$T_j = 25^\circ\text{C}$ , $V_D = 6\text{V}$	20		200	mA
$R_{th(j-c)}$	Thermal resistance junction to case	Single side cooled per chip			0.065	$^\circ\text{C}/\text{W}$
$R_{th(c-s)}$	Thermal resistance case to sink	Single side cooled per chip			0.024	$^\circ\text{C}/\text{W}$
$V_{ISO}$	Isolation voltage	50Hz, RMS, $t = 1\text{min}$ , $I_{ISO} : 1\text{mA (MAX)}$	3000			V
$F_M$	Mounting torque - copper plate (M6)		4.5		6.0	N·m
	Mounting torque - terminal (M8)		10.0		12.0	N·m
$T_{stg}$	Storage Temperature		-40		125	$^\circ\text{C}$
$T_j$	Operating Temperature		-40		125	$^\circ\text{C}$
$W_t$	Weight			1540		g
Outline	416F3					

On-state voltage Vs. peak on-state current

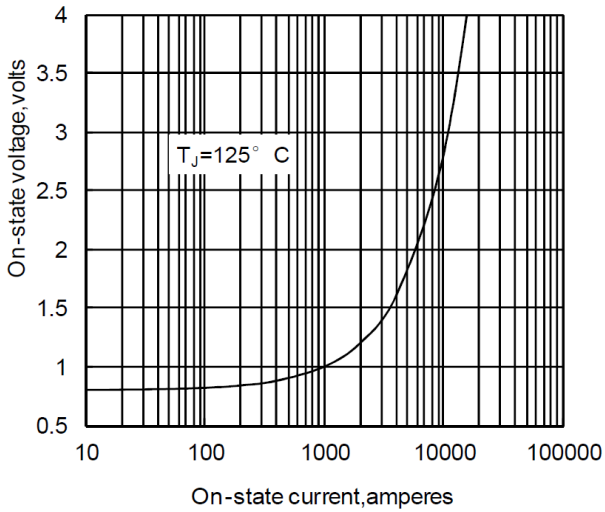


Fig.1

Max. junction to case thermal impedance Vs. time

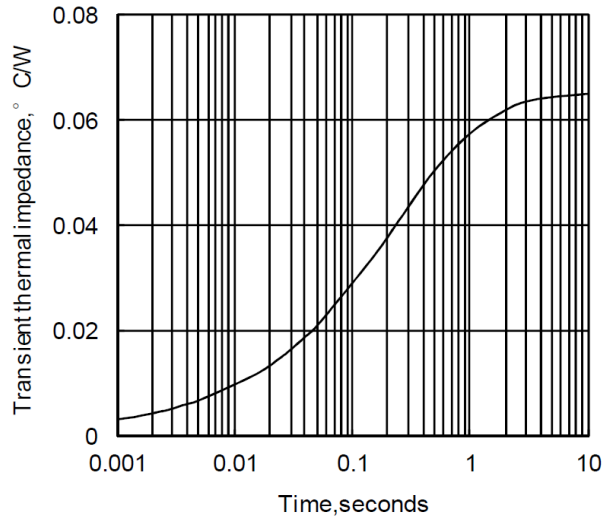


Fig.2

Max. power dissipation Vs. mean on-state current

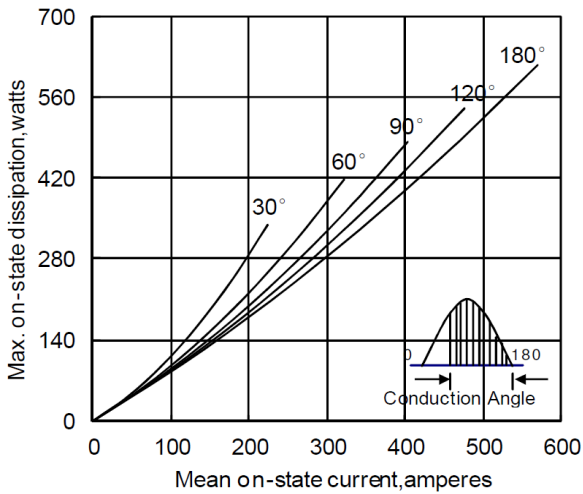


Fig.3

Max. case temperature Vs. mean on-state current

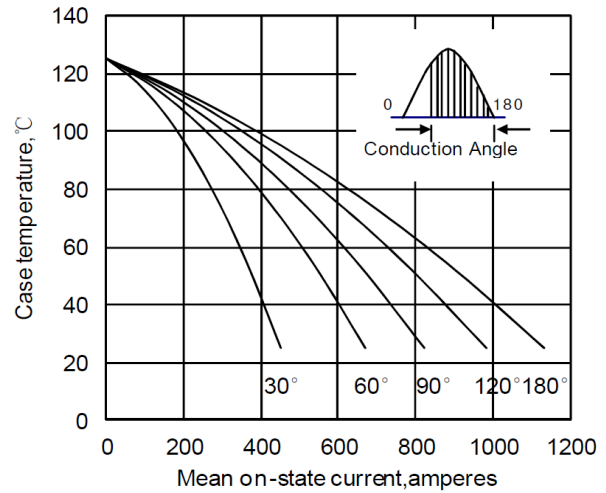


Fig.4

Max. power dissipation Vs. mean on-state current

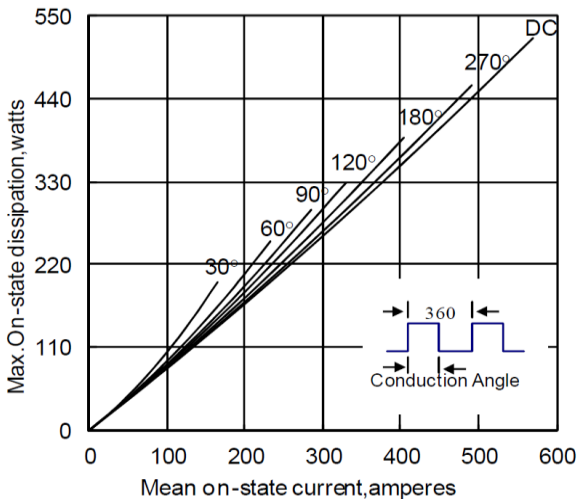


Fig.5

Max. case temperature Vs. mean on-state current

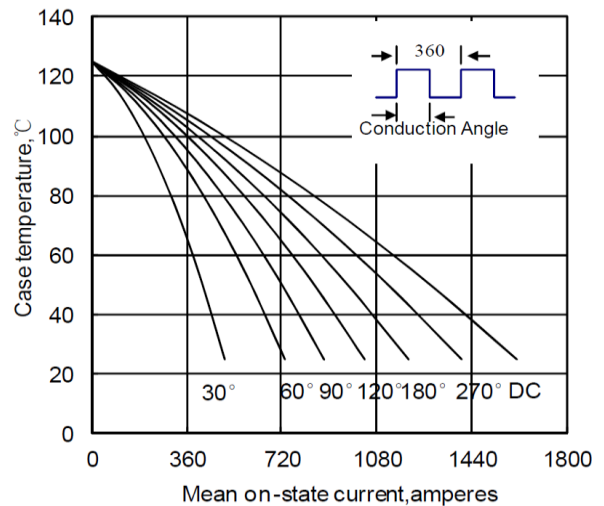


Fig.6

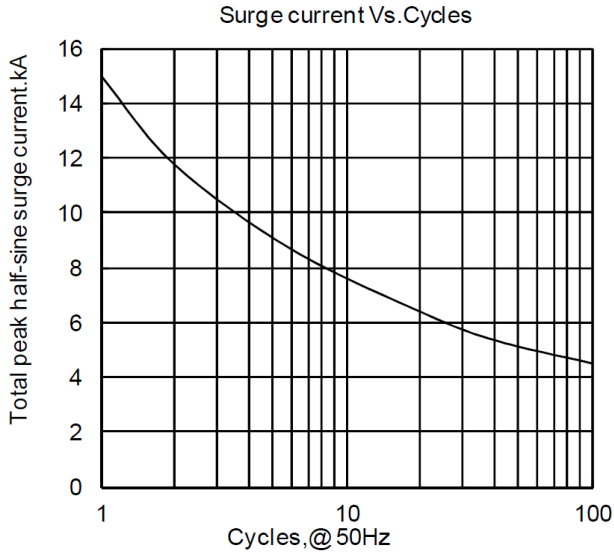


Fig.7

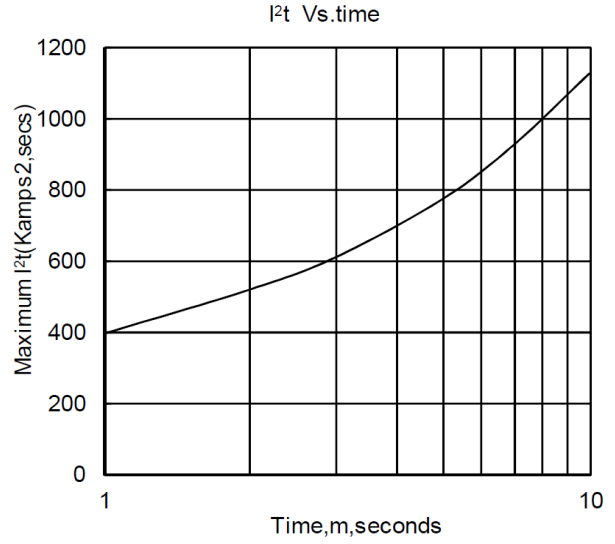


Fig.8

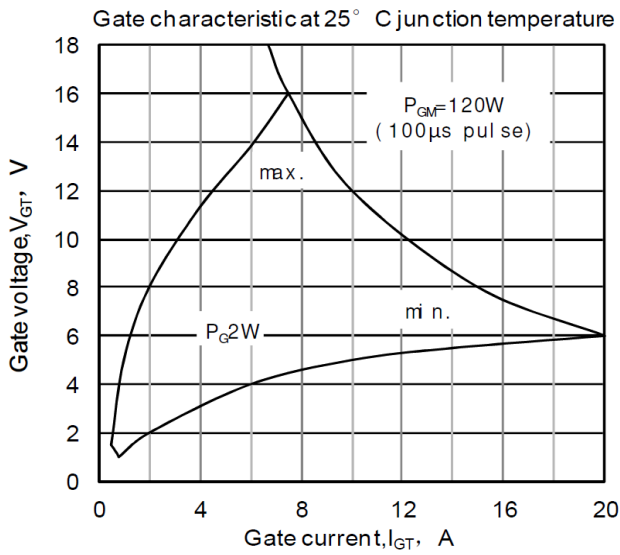


Fig.9

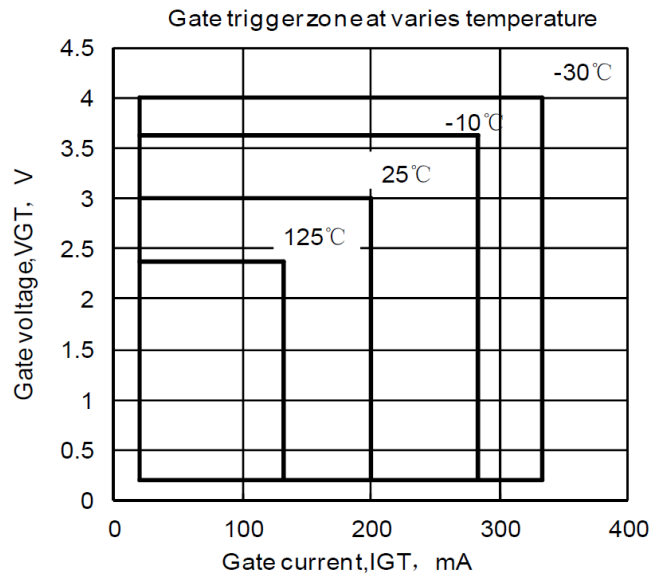
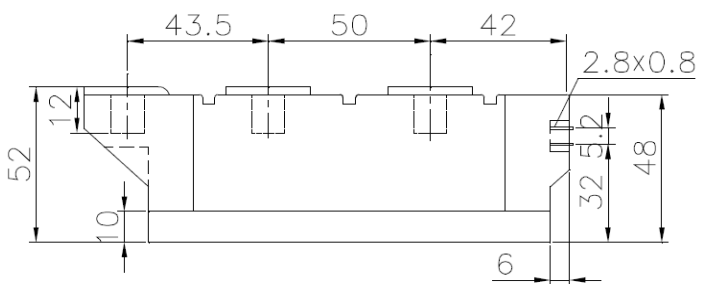
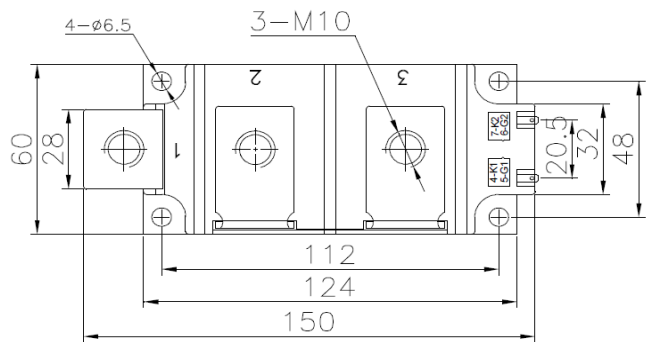


Fig.10



(dimensions in mm)



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